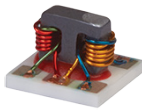
Surface Mount

Directional Coupler

DBTC-13-5-75+

75Ω, 13dB coupling, 5 to 1500 MHz



Generic photo used for illustration purposes only

CASE STYLE: AT790-1

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost

Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

Features

- very flat coupling
- very broadband, multi octave
- temperature stable, LTCC base
- all welded construction
- leads attached for better solderability
- micro miniature coupler
- aqueous washable
- protected by US Patents 6,140,887 & 6,784,521

Applications

- VHF/UHF receivers/transmitters
- cellular
- catv

Electrical Specifications at 25°C

Parameter	Condition (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		5		1500	MHz
Mainline Loss[1]	5-50		0.9	1.4	dB
	50-500		1.0	1.5	
	500-1000		1.1	1.6	
	1000-1500		1.4	2.2	
Nominal Coupling	5-1000		13.5±0.5		dB
	1000-1500		13.6±0.5		
Coupling Flatness(±)	5-1000			±0.6	dB
	1000-1500			±0.8	
Directivity	5-50	17	21		dB
	50-500	14	19		
	500-1000	—	18		
	1000 -1500	—	17		
VSWR[2]	5-1000		1.3		dB
	1000-1500		1.3		
Input Power	5-50			0.5	W
	50-500			1.0	
	500-1000			1.0	
	1000-1500			1.0	

1. Includes theoretical coupled power loss of 0.21 dB at 13 dB coupling.
2. For coupled port VSWR above 500 MHz, 1.6:1 typ.

Maximum Ratings

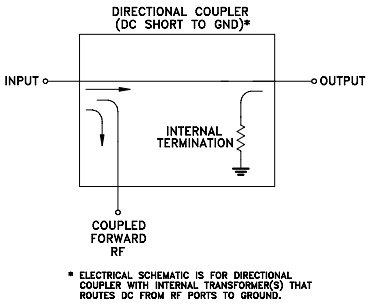
Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C

Permanent damage may occur if any of these limits are exceeded.

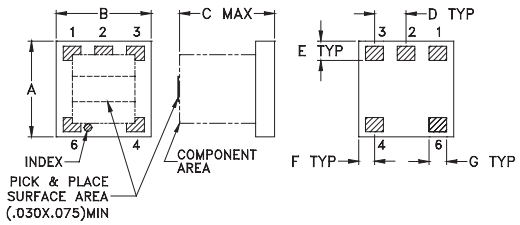
Pin Connections

Function	Pin Number
INPUT	3
OUTPUT	4
COUPLED	1
GROUND	2
ISOLATE (DO NOT USE)	6

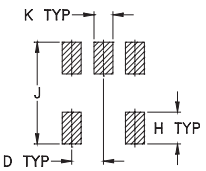
Electrical Schematic



Outline Drawing



PCB Land Pattern

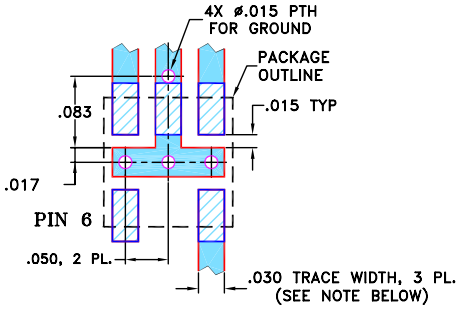


Suggested Layout,
Tolerance to be within ±.002

Outline Dimensions (inch / mm)

A	B	C	D	E	F	G	H	J	K	wt
.150	.150	.150	.050	.030	.025	.028	.050	.160	.030	grams
3.81	3.81	3.81	1.27	0.76	0.64	0.71	1.27	4.06	0.76	0.10

Demo Board MCL P/N: TB-279
Suggested PCB Layout (PL-151)



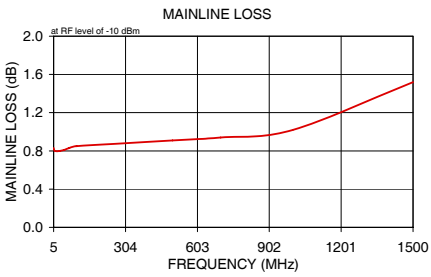
NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

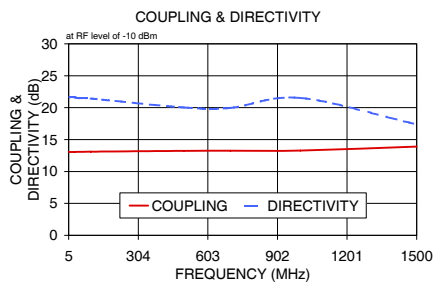
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

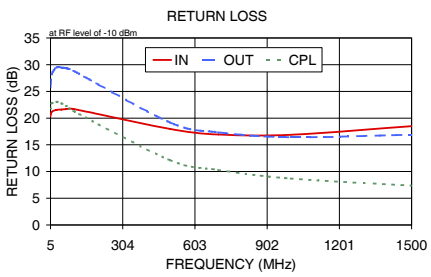
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Typical Performance Data

Frequency (MHz)	Mainline Loss (dB) In-Out	Coupling (dB) In-Cpl	Directivity (dB)	Return Loss (dB) In	Return Loss (dB) Out	Return Loss (dB) Cpl
5.00	0.83	13.09	21.69	20.33	25.83	21.73
10.00	0.80	13.06	21.61	21.17	28.18	22.73
30.00	0.80	13.06	21.61	21.55	29.45	23.06
50.00	0.81	13.07	21.48	21.61	29.48	22.74
70.00	0.83	13.09	21.51	21.69	29.33	22.26
100.00	0.85	13.11	21.42	21.72	28.86	21.33
500.00	0.91	13.23	20.04	17.98	19.17	12.15
700.00	0.94	13.26	19.95	16.94	17.35	10.31
1000.00	1.02	13.29	21.53	16.89	16.41	8.68
1500.00	1.52	13.90	17.38	18.50	16.87	7.37







Additional Notes

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

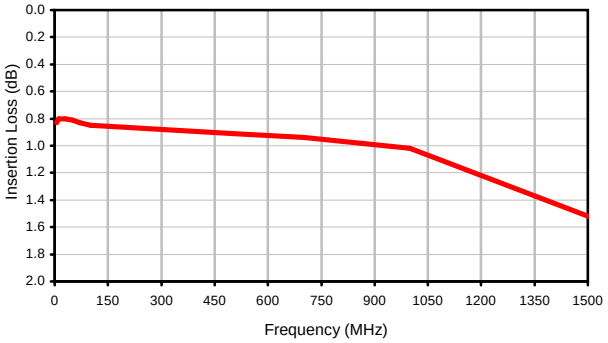
Directional Coupler DBTC-13-5-75+

Typical Performance Data

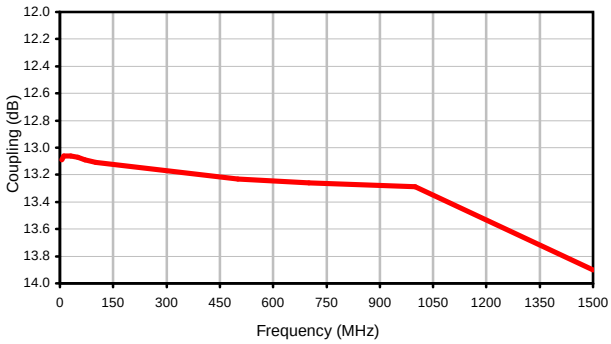
FREQUENCY (MHz)	INSERTION LOSS (dB)	COUPLING (dB)	DIRECTIVITY (dB)	RETURN LOSS (dB)		
				IN	OUT	CPL
5.0	0.83	13.09	21.69	20.33	25.83	21.73
10.0	0.80	13.06	21.61	21.17	28.18	22.73
30.0	0.80	13.06	21.61	21.55	29.45	23.06
50.0	0.81	13.07	21.48	21.61	29.48	22.74
70.0	0.83	13.09	21.51	21.69	29.33	22.26
100.0	0.85	13.11	21.42	21.72	28.86	21.33
500.0	0.91	13.23	20.04	17.98	19.17	12.15
700.0	0.94	13.26	19.95	16.94	17.35	10.31
1000.0	1.02	13.29	21.53	16.89	16.41	8.68
1500.0	1.52	13.90	17.38	18.50	16.87	7.37

Typical Performance Curves

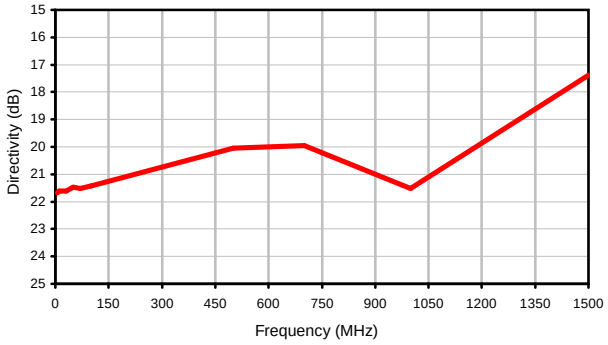
Insertion Loss



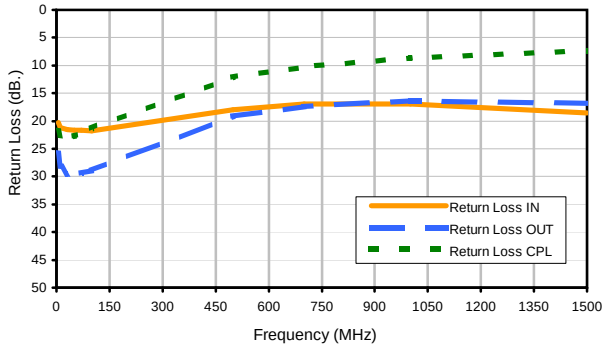
Coupling



Directivity



Return Loss

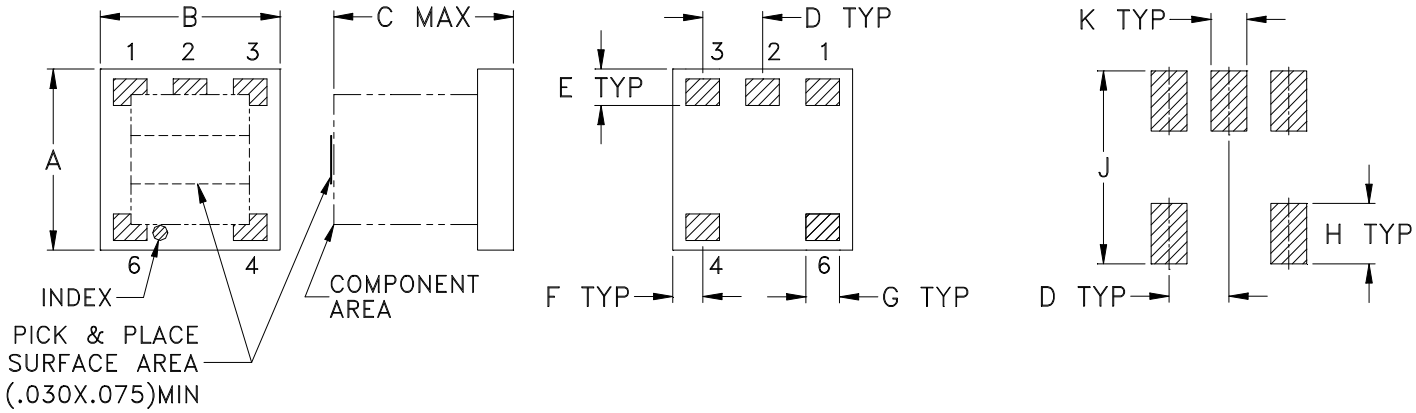


Case Style AT

Outline Dimensions

AT790-1

PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

CASE #	A	B	C	D	E	F	G	H	J	K	L	WT. GRAMS
AT790-1	.150 (3.81)	.150 (3.81)	.150 (3.81)	.050 (1.27)	.030 (0.76)	.025 (0.64)	.028 (0.71)	.050 (1.27)	.160 (4.06)	.030 (0.76)	-- --	.10

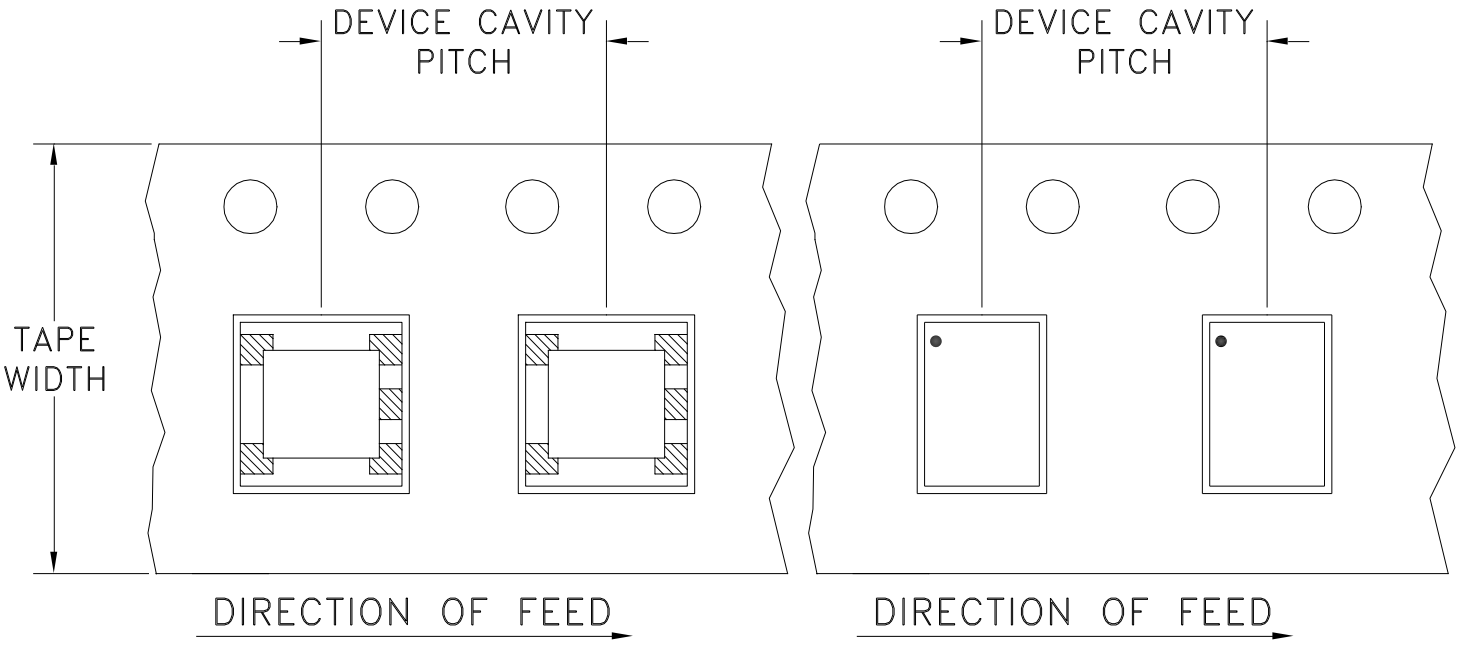
Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

1. Open style, Ceramic base.
2. Termination finish: Silver palladium or gold over nickel based on stock availability

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



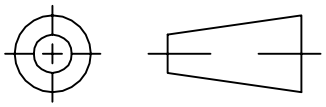
Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
12	8	7	Small quantity standards (see note)	20
				50
				100
				200
				500
		13	Standard	1000
				2000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

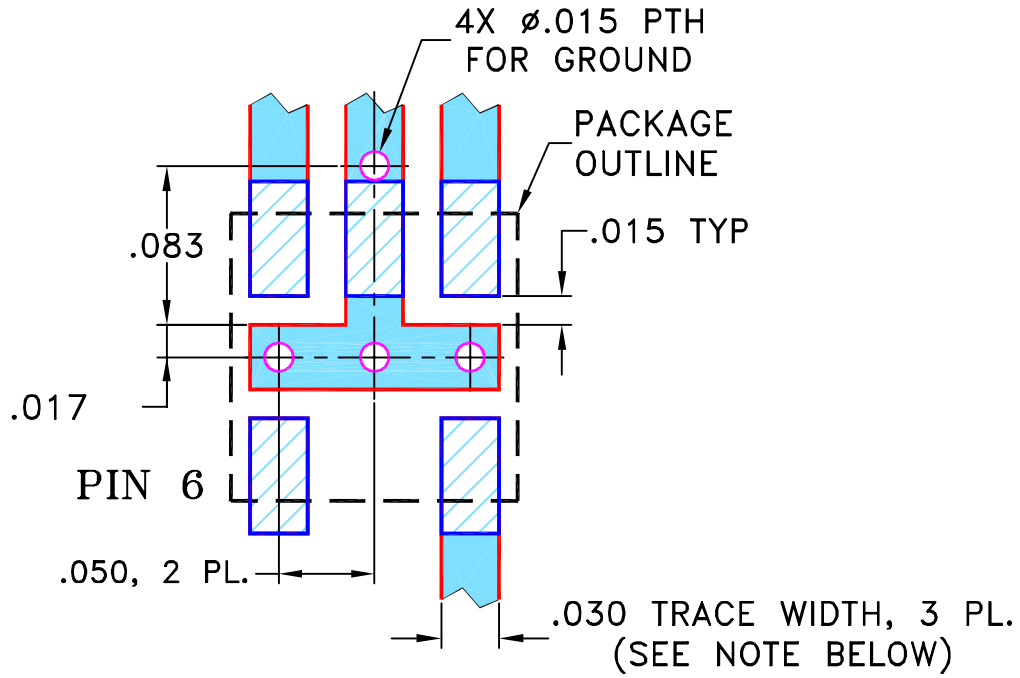
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M90455	NEW RELEASE	01/16/04	AV	WP
A	M102713	ADDED "...WITH SMOBC"	01/17/06	MMG	IL

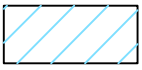
SUGGESTED MOUNTING CONFIGURATION FOR AT1029 CASE STYLE, "na" PIN CONNECTION



NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.

2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED		INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN	AV	01/07/04
TOLERANCES ON:	CHECKED	IL	01/16/04
2 PL DECIMALS ±	APPROVED	WP	01/16/04
3 PL DECIMALS ± .005			
ANGLES ±			
FRACTIONS ±			

ASHEETA1.DWG REV:A DATE:01/12/95

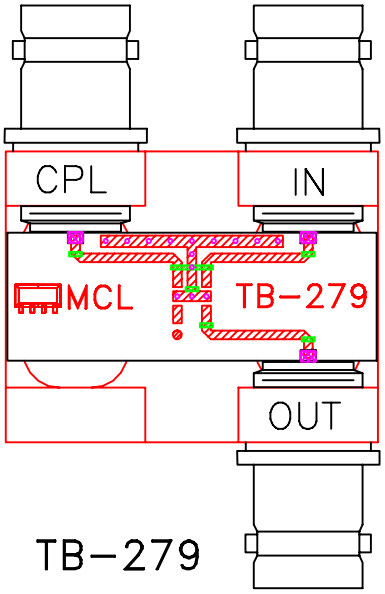
Mini-Circuits® 13 Neptune Avenue Brooklyn NY 11235

PL, na, 75, AT1029, DBTC, TB-279

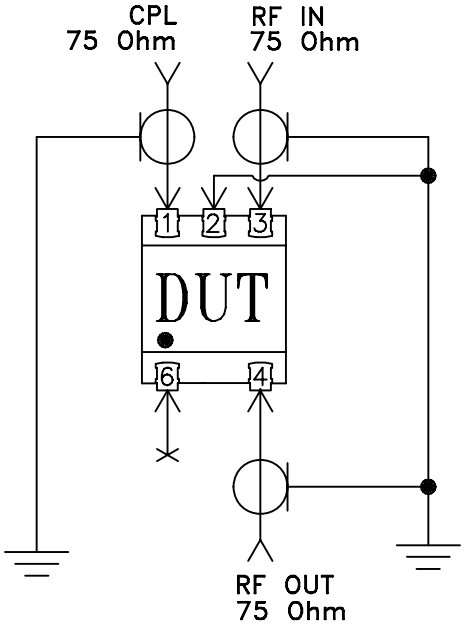
SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-151	A

FILE:	SCALE:	SHEET:
98PL151	10:1	1 OF 1

Evaluation Board and Circuit



TB-279



Schematic Diagram

Notes:

1. BNC Female connectors.
2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.

Mini-Circuits®

Mini-Circuits

Environmental Specifications ENV02T1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215